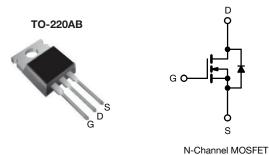




D Series Power MOSFET

PRODUCT SUMMARY				
V_{DS} (V) at T_{J} max.	550			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	1.5		
Q _g max. (nC)	20			
Q _{gs} (nC)	3			
Q _{gd} (nC)	5			
Configuration	Single			



· Material categorization: for definitions of compliance

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- SMPS
- Industrial
 - Welding

 - Motor drives
- · Battery chargers

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP5N50D-E3			
Lead (Pb)-free and Halogen-free	SiHP5N50D-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	500		
Gate-Source Voltage		V	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30		
Continuous Drain Current (T. 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		5.3		
Continuous Drain Current (T _J = 150 °C)	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	3.4	А	
Pulsed Drain Current ^a	I _{DM}	10			
Linear Derating Factor		0.83	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	28.8	mJ		
Maximum Power Dissipation	PD	104	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt -	24	1//20	
Reverse Diode dV/dt ^d	0.28		V/ns		
Soldering Recommendations (Peak temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_q = 25 Ω , I_{AS} = 5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, starting $T_J = 25$ °C.

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COMPLIANT HALOGEN

FREE

- Avalanche energy rated (UIS)

- Reduced capacitive switching losses

- Low area specific on-resistance

- Low input capacitance (Ciss)

- High body diode ruggedness

- Optimal efficiency and operation
 - Low cost

FEATURES Optimal design

- Simple gate drive circuitry
- Low figure-of-merit (FOM): Ron x Qg
- Fast switching
- please see www.vishay.com/doc?99912

- · Server and telecom power supplies
- Induction heating



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.2	0/W

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	1	V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	μA
Zero Gale voltage Drain Current	I _{DSS}	V _{DS} = 400 V	∕, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 2.5 A	-	1.2	1.5	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} :	= 20 V, I _D = 2.5 A	-	1.8	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	325	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	34	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V		-	31	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	41	-	
Total Gate Charge	Qg			-	10	20	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 2.5 \text{ A}, V_{DS} = 400 \text{ V}$		-	3	-	nC
Gate-Drain Charge	Q _{gd}				5	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$ $R_{g} = 9.1 \Omega, \text{ V}_{GS} = 10 \text{ V}$		-	12	24	
Rise Time	t _r			-	11	22	- ns
Turn-Off Delay Time	t _{d(off)}			-	14	28	
Fall Time	t _f			-	11	22	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	1.7	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	5	^
Pulsed Diode Forward Current	I _{SM}			-	-	20	A
Diode Forward Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 4 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 2.5 \text{ A},$ dl/dt = 100 A/µs, V _R = 20 V		-	320	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.2	-	μC
Reverse Recovery Current	I _{RRM}			-	8	-	Α

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

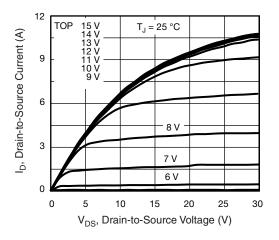


Fig. 1 - Typical Output Characteristics

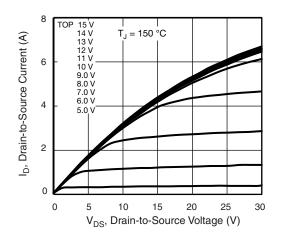


Fig. 2 - Typical Output Characteristics

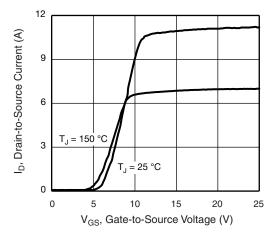


Fig. 3 - Typical Transfer Characteristics

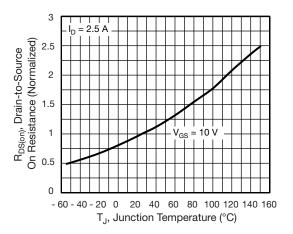


Fig. 4 - Normalized On-Resistance vs. Temperature

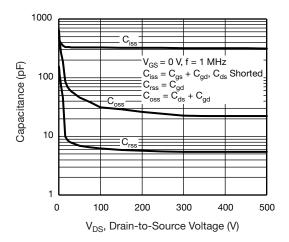


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

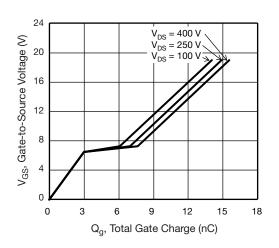


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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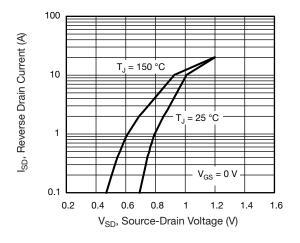
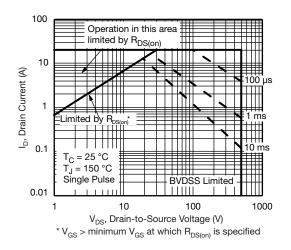


Fig. 7 - Typical Source-Drain Diode Forward Voltage





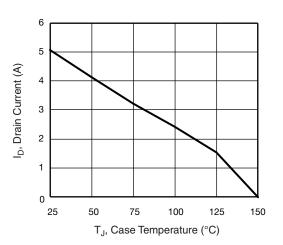


Fig. 9 - Maximum Drain Current vs. Case Temperature

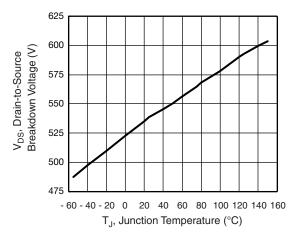
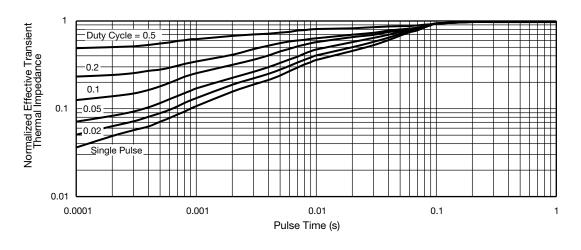


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





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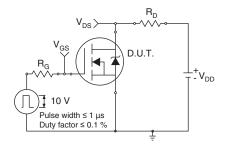


Fig. 12 - Switching Time Test Circuit

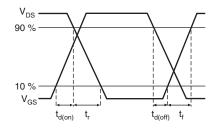


Fig. 13 - Switching Time Waveforms

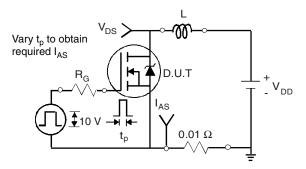


Fig. 14 - Unclamped Inductive Test Circuit

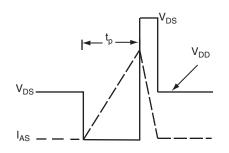


Fig. 15 - Unclamped Inductive Waveforms

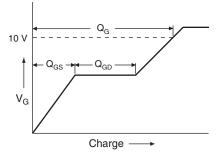


Fig. 16 - Basic Gate Charge Waveform

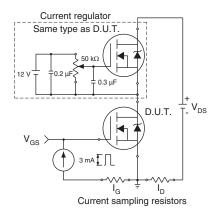
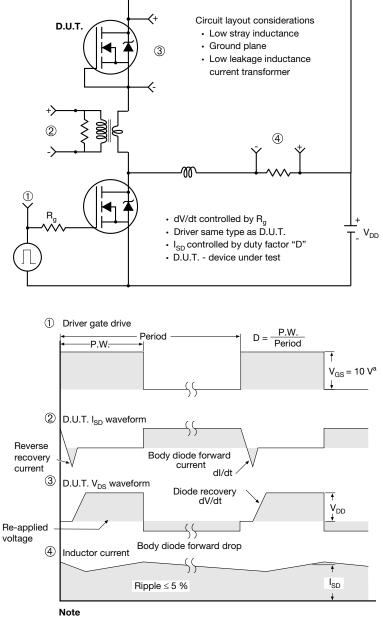


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

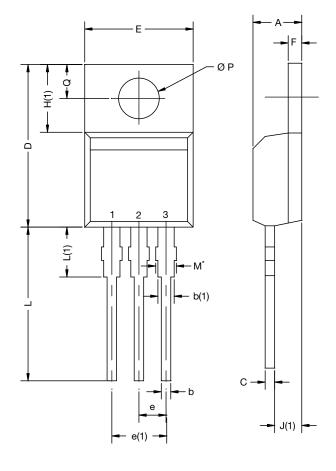
Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIMETERS		INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
ASE		Xi'an		
		IRF 9510 744K AB		

Revison: 14-Dec-15

Document Number: 66542

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